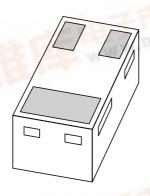
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS3515M 15 V, 0.5 A PNP low V_{CEsat} (BISS) transistor

Product specification







15 V, 0.5 A PNP low V_{CEsat} (BISS) transistor

PBSS3515M

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- $\bullet\,$ High collector current capability I_C and I_{CM}
- High efficiency leading to reduced heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management:
 - DC-DC converter
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- · Peripheral driver:
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load drivers (e.g. relays, buzzers and motors).

DESCRIPTION

Low V_{CEsat} PNP transistor in a SOT883 leadless ultra small plastic package.

NPN complement: PBSS2515M.

MARKING

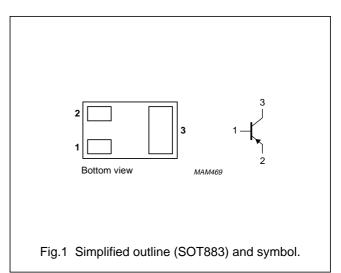
TYPE NUMBER	MARKING CODE
PBSS3515M	DB

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-15	V
Ic	collector current (DC)	-500	mA
I _{CM}	peak collector current -1		
R _{CEsat}	equivalent on-resistance <500 m		mΩ

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER CONDITIONS		MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-15	V
V _{CEO}	collector-emitter voltage	open base	_	-15	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
Ic	collector current (DC)	notes 1 and 2	_	-500	mA
I _{CM}	peak collector current		_	-1	Α
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; notes 1 and 2	_	250	mW
		T _{amb} ≤ 25 °C; note 1 and 3	_	430	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to SOT883 standard mounting conditions.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60 μm copper strip line.
- 3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air; notes 1 and 2	500	K/W
	ambient	in free air; notes 1, 3 and 4	290	K/W

Notes

- 1. Refer to SOT883 standard mounting conditions.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60 μ m copper strip line.
- 3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 4. Operated under pulsed conditions: duty cycle $\delta \leq$ 20%, pulse width $t_p \leq$ 30 ms.

Soldering

Reflow soldering is the only recommended soldering method.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

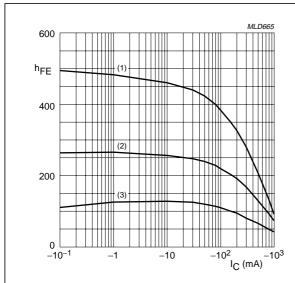
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -15 \text{ V}; I_E = 0$	_	_	-100	nA
		$V_{CB} = -15 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -10 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note } 1$	150	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}; \text{ note 1}$	90	_	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -0.5 \text{ mA}$	_	_	-25	mV
		$I_C = -200 \text{ mA}; I_B = -10 \text{ mA}; \text{ note 1}$	_	_	-150	mV
		$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	_	_	-250	mV
R _{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}; \text{ note 1}$	_	300	<500	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	_	_	-1.1	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note } 1$	_	_	-0.9	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	280	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	10	pF

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

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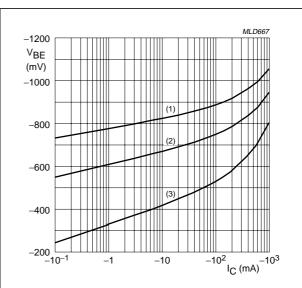
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 $V_{CE} = -2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

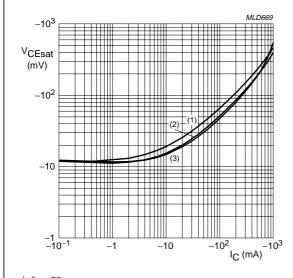
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 \text{ V}.$

- (1) $T_{amb} = -55 \,^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) T_{amb} = 150 °C.

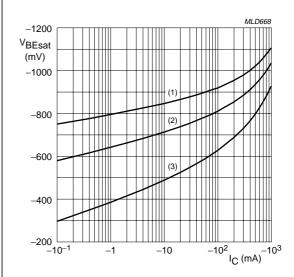
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

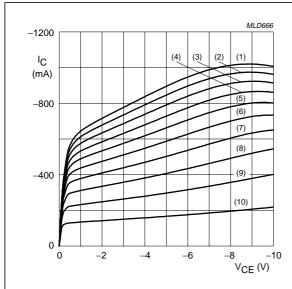
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- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

ig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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 $T_{amb} = 25 \, ^{\circ}C.$

(1) $I_B = -7 \text{ mA}$.

(5) $I_B = -4.2 \text{ mA}.$

(9) $I_B = -1.4 \text{ mA}.$

(2) $I_B = -6.3 \text{ mA}.$

(6) $I_B = -3.5 \text{ mA}.$

(10) $I_B = -0.7 \text{ mA}$.

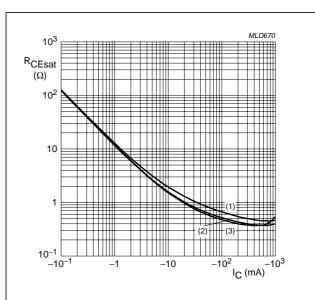
(3) $I_B = -5.6 \text{ mA}.$

(7) $I_B = -2.8 \text{ mA}.$

(4) $I_B = -4.9 \text{ mA}.$

(8) $I_B = -2.1 \text{ mA}.$

Fig.6 Collector current as a function of collector-emitter voltage; typical values.



 $I_{\rm C}/I_{\rm B}=20.$

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(1) T_{amb} = 150 °C.

(2) $T_{amb} = 25 \, ^{\circ}C$.

(3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.7 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

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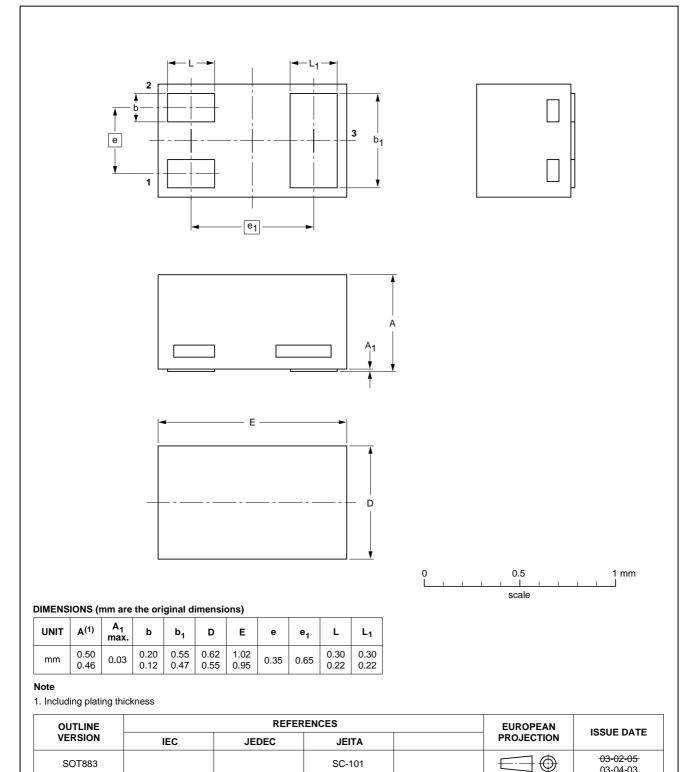
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03-04-03

PACKAGE OUTLINE

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



15 V, 0.5 A PNP low V_{CEsat} (BISS) transistor

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

613514/01/pp9

Date of release: 2003 Jul 22

Document order number: 9397 750 11558

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